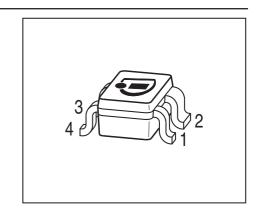


#### Low Noise Silicon Bipolar RF Transistor

- General purpose low noise amplifier for low voltage, low current applications
- High ESD robustness, typical 1500 V (HBM)
- Low minimum noise figure 1.1 dB at 1.8 GHz
- High linearity: output compression point
   OP1dB = 13 dBm @ 3 V, 35 mA, 1.8 GHz
- Pb-free (RoHS compliant) and halogen-free package with visible leads
- Qualification report according to AEC-Q101 available







#### **ESD** (Electrostatic discharge) sensitive device, observe handling precaution!

| Туре   | Marking | Pin Configuration |       |       |     |   | Package |        |
|--------|---------|-------------------|-------|-------|-----|---|---------|--------|
| BFP460 | ABs     | 1 = E             | 2 = C | 3 = E | 4=B | - | -       | SOT343 |

**Maximum Ratings** at  $T_A$  = 25 °C, unless otherwise specified

| Parameter                             | Symbol             | Value   | Unit |
|---------------------------------------|--------------------|---------|------|
| Collector-emitter voltage             | $V_{\sf CEO}$      |         | V    |
| <i>T</i> <sub>A</sub> = 25 °C         |                    | 4.5     |      |
| <i>T</i> <sub>A</sub> = -55 °C        |                    | 4.2     |      |
| Collector-emitter voltage             | $V_{CES}$          | 15      |      |
| Collector-base voltage                | $V_{\mathrm{CBO}}$ | 15      |      |
| Emitter-base voltage                  | $V_{EBO}$          | 1.5     |      |
| Collector current                     | I <sub>C</sub>     | 70      | mA   |
| Base current                          | l <sub>B</sub>     | 7       |      |
| Total power dissipation <sup>1)</sup> | P <sub>tot</sub>   | 230     | mW   |
| <i>T</i> <sub>S</sub> ≤ 92°C          |                    |         |      |
| Junction temperature                  | TJ                 | 150     | °C   |
| Ambient temperature                   | T <sub>A</sub>     | -65 150 |      |
| Storage temperature                   | $T_{Sta}$          | -65 150 |      |

 $<sup>{}^1</sup>T_{
m S}$  is measured on the collector lead at the soldering point to the pcb



#### **Thermal Resistance**

| Parameter                                | Symbol            | Value | Unit |
|--|-------------------|-------|------|
| Junction - soldering point <sup>1)</sup> | R <sub>thJS</sub> | 250   | K/W  |

### **Electrical Characteristics** at $T_A$ = 25 °C, unless otherwise specified

| Parameter  | Symbol               | Values |      |      | Unit |
|--|----------------------|--------|------|------|------|
|  |                      | min.   | typ. | max. |      |
| DC Characteristics   | •                    |        |      | •    | •    |
| Collector-emitter breakdown voltage                                | V <sub>(BR)CEO</sub> | 4.5    | 5.8  | -    | V    |
| $I_{\rm C}$ = 1 mA, $I_{\rm B}$ = 0                                | , ,                  |        |      |      |      |
| Collector-emitter cutoff current                                   | I <sub>CES</sub>     |        |      |      | nA   |
| $V_{CE} = 15 \text{ V}, V_{BE} = 0$                                |                      | -      | -    | 1000 |      |
| $V_{CE} = 2 \text{ V}, V_{BE} = 0$                                 |                      | -      | 1    | 30   |      |
| $V_{\text{CE}}$ = 5 V, $V_{\text{BE}}$ = 0 , $T_{\text{A}}$ = 85°C |                      | -      | 2    | 40   |      |
| Verified by random sampling  |                      |        |      |      |      |
| Collector-base cutoff current                                      | I <sub>CBO</sub>     |        |      |      |      |
| $V_{\rm CB} = 2 \text{ V}, I_{\rm E} = 0$                          |                      | -      | 1    | 30   |      |
| $V_{\rm CB} = 5 \text{ V}, I_{\rm E} = 0$                          |                      | -      | -    | 30   |      |
| Emitter-base cutoff current  | / <sub>EBO</sub>     | -      | 1    | 500  |      |
| $V_{\rm EB} = 0.5  \rm V,  I_{\rm C} = 0$                          |                      |        |      |      |      |
| DC current gain  | h <sub>FE</sub>      | 90     | 120  | 160  | _    |
| $V_{\rm CE}$ = 3 V, $I_{\rm C}$ = 20 mA , pulse measured           |                      |        |      |      |      |

 $<sup>^{1}</sup>$ For the definition of  $R_{\mathrm{thJS}}$  please refer to Application Note AN077 (Thermal Resistance Calculation)



**Electrical Characteristics** at  $T_{\rm A}$  = 25 °C, unless otherwise specified

| Parameter   | Symbol            | Values |      |      | Unit |  |
|---|-------------------|--------|------|------|------|--|
|   |                   | min.   | typ. | max. |      |  |
| AC Characteristics (verified by random sampling)                        |                   |        |      |      |      |  |
| Transition frequency  | $f_{T}$           | 16     | 22   | -    | GHz  |  |
| $I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 3 V, $f$ = 1 GHz                    |                   |        |      |      |      |  |
| Collector-base capacitance  | C <sub>cb</sub>   | -      | 0.32 | 0.45 | pF   |  |
| $V_{CB} = 3 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$ ,                 |                   |        |      |      |      |  |
| emitter grounded  |                   |        |      |      |      |  |
| Collector emitter capacitance   | C <sub>ce</sub>   | -      | 0.28 | -    |      |  |
| $V_{CE} = 3 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$ ,                 |                   |        |      |      |      |  |
| base grounded   |                   |        |      |      |      |  |
| Emitter-base capacitance  | C <sub>eb</sub>   | -      | 0.55 | -    |      |  |
| $V_{\text{EB}} = 0.5 \text{ V}, f = 1 \text{ MHz}, V_{\text{CB}} = 0$ , |                   |        |      |      |      |  |
| collector grounded  |                   |        |      |      |      |  |
| Minimum noise figure  | NF <sub>min</sub> |        |      |      | dB   |  |
| $V_{CE}$ = 2V, $I_{C}$ = 3 mA , $Z_{S}$ = $Z_{Sopt}$ , $f$ = 100 MHz    |                   | -      | 0.7  | -    |      |  |
| $V_{CE} = 3V$ , $I_{C} = 5$ mA , $Z_{S} = Z_{Sopt}$ , $f = 1.8$ GHz     |                   | -      | 1.1  | -    |      |  |
| $V_{CE} = 3V$ , $I_{C} = 5$ mA , $Z_{S} = Z_{Sopt}$ , $f = 3$ GHz       |                   | -      | 1.2  | -    |      |  |



**Electrical Characteristics** at  $T_A$  = 25 °C, unless otherwise specified

| Parameter   | Symbol                          | Values |      |      | Unit |
|---|---------------------------------|--------|------|------|------|
|   |                                 | min.   | typ. | max. |      |
| AC Characteristics (verified by random sampling   | )                               |        |      |      |      |
| Maximum power Gain <sup>1)</sup>  | G <sub>max</sub>                |        |      |      | dB   |
| $I_{\rm C}$ = 3 mA, $V_{\rm CE}$ = 1.5 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$ , $Z_{\rm L}$ = $Z_{\rm Lopt}$ ,     |                                 |        |      |      |      |
| f = 100 MHz   |                                 | _      | 26.5 | -    |      |
| $I_{C}$ = 20 mA, $V_{CE}$ = 3 V, $Z_{S}$ = $Z_{Sopt}$ , $Z_{L}$ = $Z_{Lopt}$ ,                              |                                 |        |      |      |      |
| f = 1,8 GHz   |                                 | _      | 17.5 | -    |      |
| f = 3 GHz   |                                 | -      | 12.5 | -    |      |
| Transducer gain   | S <sub>21e</sub>   <sup>2</sup> |        |      |      | dB   |
| $I_{\rm C}$ = 3 mA, $V_{\rm CE}$ = 1.5 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 $\Omega$ ,                         |                                 |        |      |      |      |
| f = 100 MHz   |                                 | _      | 20   | -    |      |
| $I_{\rm C}$ = 20 mA, $V_{\rm CE}$ = 3 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 $\Omega$ ,                          |                                 |        |      |      |      |
| f = 1.8 GHz   |                                 | -      | 15   | -    |      |
| f = 3 GHz   |                                 | -      | 10.5 | -    |      |
| Third order intercept point at output <sup>2)</sup>   | IP3                             |        |      |      | dBm  |
| $V_{\text{CE}}$ = 3 V, $I_{\text{C}}$ = 20 mA, $f$ = 100 MHz  |                                 | -      | 23.5 | -    |      |
| $V_{\text{CE}}$ = 3 V, $I_{\text{C}}$ = 20 mA, $f$ = 1.8 GHz  |                                 | -      | 27.5 | -    |      |
| 1dB compression point at output   | P <sub>-1dB</sub>               |        |      |      |      |
| $V_{\text{CE}}$ = 3V, $I_{\text{C}}$ = 20mA , $Z_{\text{S}}$ = $Z_{\text{L}}$ = 50 $\Omega$ , $f$ = 100 MHz |                                 | -      | 9.5  | -    |      |
| $V_{\rm CE}$ = 3V, $I_{\rm C}$ = 20mA, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 $\Omega$ , $f$ = 1.8 GHz              |                                 | _      | 11.5 | _    |      |
| $V_{\rm CE}$ = 3V, $I_{\rm C}$ = 35mA, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 $\Omega$ , $f$ = 1.8 GHz              |                                 | -      | 13   | -    |      |

 $<sup>{}^{1}</sup>G_{ma} = |S_{21} / S_{12}| (k-(k^{2}-1)^{1/2}), G_{ms} = |S_{21} / S_{12}|$ 

<sup>&</sup>lt;sup>2</sup>IP3 value depends on termination of all intermodulation frequency components.

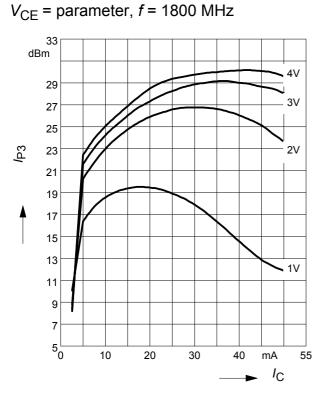
Termination used for this measurement is  $50\Omega$  from 0.1 MHz to 6 GHz



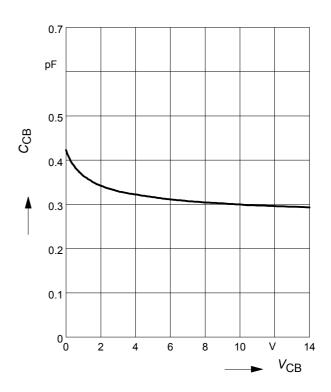
# Total power dissipation $P_{tot} = f(T_S)$

# 260 V 220 200 180 160 140 120 100 80 60 40 20 0 15 30 45 60 75 90 105 120 A 150

# Third order Intercept Point $IP3 = f(I_C)$ (Output, $Z_S = Z_L = 50\Omega$ )



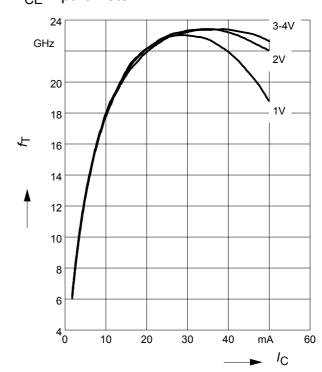
# Collector-base capacitance $C_{cb}$ = $f(V_{CB})$ f = 1MHz



# Transition frequency $f_T = f(I_C)$

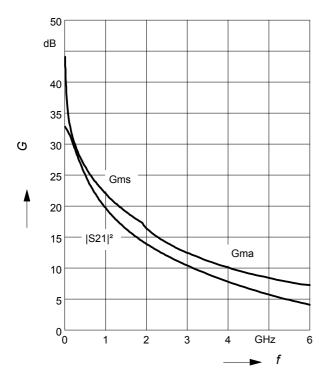
f = 1 GHz

 $V_{CE}$  = parameter





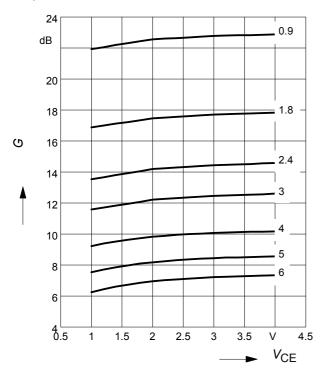
Power gain  $G_{ma}$ ,  $G_{ms}$ ,  $|S_{21}|^2 = f(f)$  $V_{CF} = 3 \text{ V}$ ,  $I_{C} = 20 \text{ mA}$ 



Power gain  $G_{ma}$ ,  $G_{ms} = f(V_{CE})$ 

 $I_{\rm C}$  = 20 mA

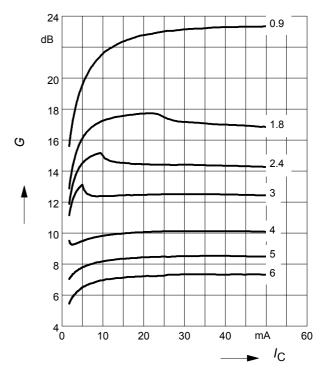
f = parameter in GHz



Power gain  $G_{ma}$ ,  $G_{ms} = f(I_C)$ 

 $V_{CE} = 3V$ 

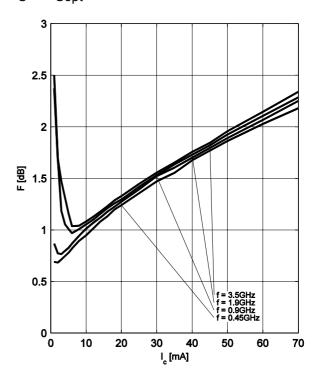
f = parameter in GHz



Noise figure  $F = f(I_C)$ 

 $V_{CE}$  = 2 V, f = parameter

 $Z_{\rm S} = Z_{\rm Sopt}$ 

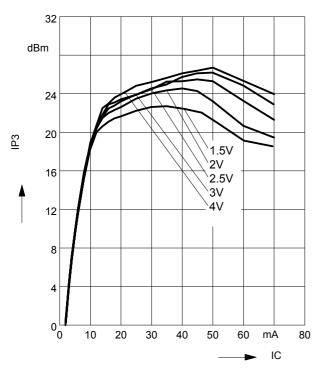




# Third order Intercept Point $IP_3 = f(I_C)$

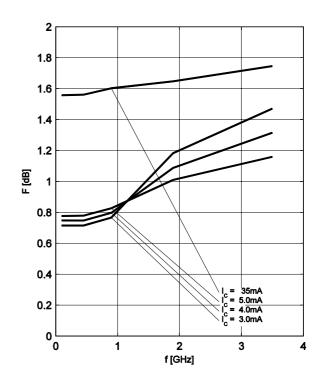
(Output,  $Z_S = Z_L = 50\Omega$ )

 $V_{CE}$  = parameter, f = 100MHz



### Noise figure F = f(f)

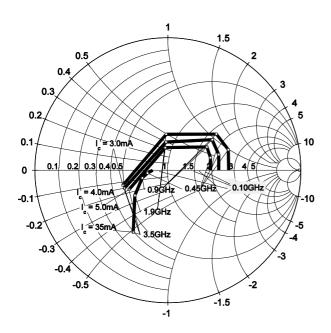
 $V_{CE}$  = 2V,  $Z_{S}$  =  $Z_{Sopt}$ ,  $I_{C}$  = parameter



# Source impedance for min.

noise figure vs. frequency

 $V_{CE} = 2V$ ,  $I_{C} = parameter$ 





#### SPICE GP Model

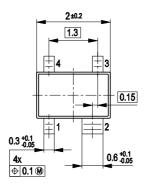
For the SPICE Gummel Poon (GP) model as well as for the S-parameters (including noise parameters) please refer to our internet website www.infineon.com/rf.models.

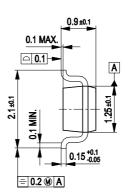
Please consult our website and download the latest versions before actually starting your design. You find the BFP460 SPICE GP model in the internet in MWO- and ADS-format, which you can import into these circuit simulation tools very quickly and conveniently. The model already contains the package parasitics and is ready to use for DC and high frequency simulations. The terminals of the model circuit correspond to the pin configuration of the device. The model parameters have been extracted and verified up to 6 GHz using typical devices. The BFP460 SPICE GP model reflects the typical DC- and RF-performance within the limitations which are given by the SPICE GP model itself. Besides the DC characteristics all S-parameters in magnitude and phase, as well as noise figure (including optimum source impedance, equivalent noise resistance and flicker noise) and intermodulation have been extracted.



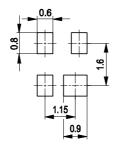
## Package Outline



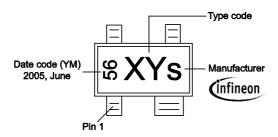




#### **Foot Print**

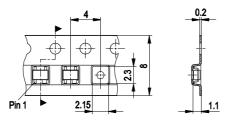


### Marking Layout (Example)



### Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel Reel ø330 mm = 10.000 Pieces/Reel





#### Edition 2009-11-16

Published by Infineon Technologies AG 81726 Munich, Germany

© 2009 Infineon Technologies AG All Rights Reserved.

#### **Legal Disclaimer**

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics. With respect to any examples or hints given herein, any typical values stated herein and/or any information regarding the application of the device, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation, warranties of non-infringement of intellectual property rights of any third party.

#### Information

For further information on technology, delivery terms and conditions and prices, please contact the nearest Infineon Technologies Office (<a href="www.infineon.com">www.infineon.com</a>).

#### Warnings

Due to technical requirements, components may contain dangerous substances. For information on the types in question, please contact the nearest Infineon Technologies Office.

Infineon Technologies components may be used in life-support devices or systems only with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.